

3x 2.4mm SMD CHIP LED LAMP



Features

- \bullet 3mm x 2.4mm SMT LED, 1.05mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- Rohs Compliant.

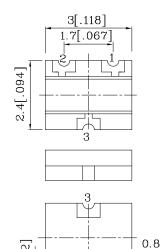




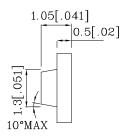
Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.20(0.008") unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Rating (TA=25°C)	MG (GaP)	Unit	
Reverse Voltage	VR	5	V
Forward Current	IF	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA
Power Dissipation	Рт	62.5	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	



[.031]



- 1. ANODE
- 2. N.C
- 3. CATHODE

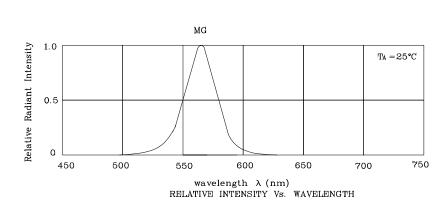
Operating Characteristics (TA=25°C)		MG (GaP)	Unit
Forward Voltage (Typ.) (IF=20mA)	VF	2.2	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	Ir	10	uA
Wavelength Of Peak Emission (Typ.) (IF=20mA)	λΡ	565	nm
Wavelength Of Dominant Emission (Typ.) (IF=20mA)	λ D	568	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	30	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	15	рF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 0 1/2
				min.	typ.		
XZMG85WA	Green	GaP	Water Clear	7	19	565	120°
Published Date : J	AN 18,2008	Drawing	No : XDSA7455	V3	Check	xed : B.L.LIU	P.1/4

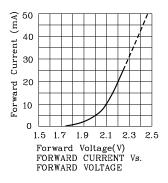


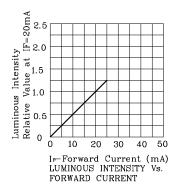
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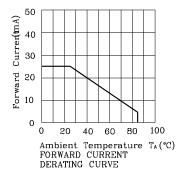


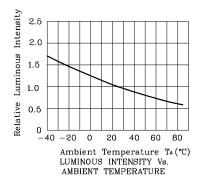


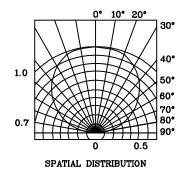
♦ MG









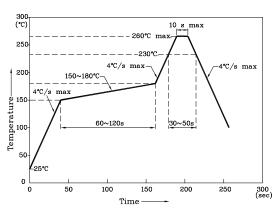


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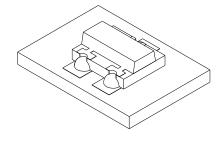


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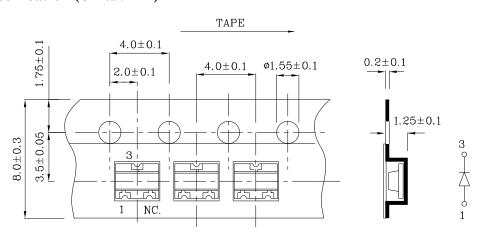
Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:
 - Maximum soldering temperature should not exceed 260°c.
 - 2. Recommended reflow temperature: 145°c-260°c.
 - 3. Do not put stress to the epoxy resin during high temperatures conditions.
- **❖** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)
- ❖ The device has a single mounting surface. The device must be mounted according to the specifications.



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

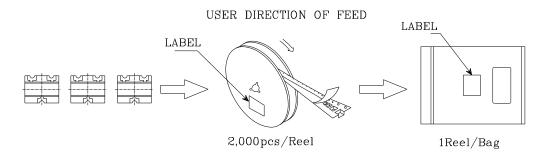


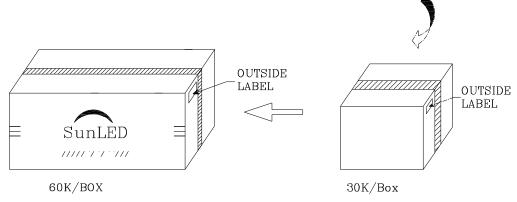
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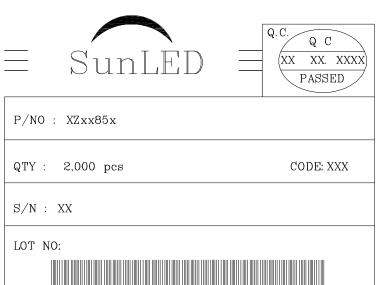


PACKING & LABEL SPECIFICATIONS

XZMG85WA







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RoHS Compliant